

RF Power LDMOS Transistor

N-Channel Enhancement-Mode Lateral MOSFET

Designed for Class A or Class AB power amplifier applications with frequencies up to 2000 MHz. Suitable for analog and digital modulation and multicarrier amplifier applications.

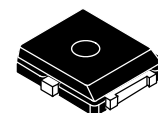
- Typical Two-Tone Performance @ 1960 MHz, 28 Vdc, $I_{DQ} = 50$ mA,
 $P_{out} = 4$ W PEP
 Power Gain — 18 dB
 Drain Efficiency — 33%
 IMD — -34 dBc
- Typical Two-Tone Performance @ 900 MHz, 28 Vdc, $I_{DQ} = 50$ mA,
 $P_{out} = 4$ W PEP
 Power Gain — 19 dB
 Drain Efficiency — 33%
 IMD — -39 dBc
- Capable of Handling 5:1 VSWR @ 28 Vdc, 1960 MHz, 4 W CW Output Power

Features

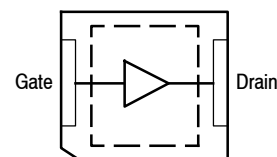
- Characterized with Series Equivalent Large-Signal Impedance Parameters
- On-Chip RF Feedback for Broadband Stability
- Integrated ESD Protection
- In Tape and Reel. T1 Suffix = 1,000 Units, 16 mm Tape Width, 7-inch Reel.

MMRF1014NT1

**1-2000 MHz, 4 W, 28 V
CLASS A/AB
RF POWER MOSFET**



**PLD-1.5
PLASTIC**



Note: The center pad on the backside of the package is the source terminal for the transistor.

Figure 1. Pin Connections

Table 1. Maximum Ratings

| Rating | Symbol | Value | Unit |
|--------------------------------|-----------|-------------|------|
| Drain-Source Voltage | V_{DSS} | -0.5, +68 | Vdc |
| Gate-Source Voltage | V_{GS} | -0.5, +12 | Vdc |
| Storage Temperature Range | T_{stg} | -65 to +150 | °C |
| Operating Junction Temperature | T_J | 150 | °C |

Table 2. Thermal Characteristics

| Characteristic | Symbol | Value (1,2) | Unit |
|-------------------------------------------------------------------------------------------------------------------|-----------------|-------------|------|
| Thermal Resistance, Junction to Case Case Temperature 76°C, 4 W PEP, Two-Tone Case Temperature 79°C, 4 W CW | $R_{\theta JC}$ | 8.8 8.5 | °C/W |

Table 3. ESD Protection Characteristics

| Test Methodology | Class |
|---------------------------------------|-------|
| Human Body Model (per JESD22-A114) | 1C |
| Machine Model (per EIA/JESD22-A115) | A |
| Charge Device Model (per JESD22-C101) | IV |

1. MTTF calculator available at <http://www.freescale.com/rf>. Select Software & Tools/Development Tools/Calculators to access MTTF calculators by product.
2. Refer to AN1955, *Thermal Measurement Methodology of RF Power Amplifiers*. Go to <http://www.freescale.com/rf>. Select Documentation/Application Notes - AN1955.

Table 4. Moisture Sensitivity Level

| Test Methodology | Rating | Package Peak Temperature | Unit |
|--------------------------------------|--------|--------------------------|------|
| Per JESD22-A113, IPC/JEDEC J-STD-020 | 3 | 260 | °C |

Table 5. Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
|----------------|--------|-----|-----|-----|------|
|----------------|--------|-----|-----|-----|------|

Off Characteristics

| | | | | | |
|---------------------------------------------------------------------------------------------------|-----------|---|---|-----|-----------------|
| Zero Gate Voltage Drain Leakage Current ($V_{DS} = 68\text{ Vdc}$, $V_{GS} = 0\text{ Vdc}$) | I_{DSS} | — | — | 10 | μAdc |
| Zero Gate Voltage Drain Leakage Current ($V_{DS} = 28\text{ Vdc}$, $V_{GS} = 0\text{ Vdc}$) | I_{DSS} | — | — | 10 | μAdc |
| Gate-Source Leakage Current ($V_{GS} = 5\text{ Vdc}$, $V_{DS} = 0\text{ Vdc}$) | I_{GSS} | — | — | 500 | nAdc |

On Characteristics

| | | | | | |
|-------------------------------------------------------------------------------------------------------------------------------------|--------------|-----|------|------|-----|
| Gate Threshold Voltage ($V_{DS} = 10\text{ Vdc}$, $I_D = 50\text{ mAdc}$) | $V_{GS(th)}$ | 1.2 | 2 | 2.7 | Vdc |
| Gate Quiescent Voltage ($V_{DS} = 28\text{ Vdc}$, $I_D = 50\text{ mAdc}$) | $V_{GS(Q)}$ | — | 2.7 | — | Vdc |
| Fixture Gate Quiescent Voltage ⁽¹⁾ ($V_{DD} = 28\text{ Vdc}$, $I_D = 50\text{ mAdc}$, Measured in Functional Test) | $V_{GG(Q)}$ | 2.2 | 3 | 4.2 | Vdc |
| Drain-Source On-Voltage ($V_{GS} = 10\text{ Vdc}$, $I_D = 50\text{ mAdc}$) | $V_{DS(on)}$ | — | 0.27 | 0.37 | Vdc |

Dynamic Characteristics

| | | | | | |
|-----------------------------------------------------------------------------------------------------------------------|-----------|---|----|---|----|
| Reverse Transfer Capacitance ($V_{DS} = 28\text{ Vdc} \pm 30\text{ mV(rms)ac}$ @ 1 MHz, $V_{GS} = 0\text{ Vdc}$) | C_{rss} | — | 21 | — | pF |
| Output Capacitance ($V_{DS} = 28\text{ Vdc} \pm 30\text{ mV(rms)ac}$ @ 1 MHz, $V_{GS} = 0\text{ Vdc}$) | C_{oss} | — | 25 | — | pF |
| Input Capacitance ($V_{DS} = 28\text{ Vdc}$, $V_{GS} = 0\text{ Vdc} \pm 30\text{ mV(rms)ac}$ @ 1 MHz) | C_{iss} | — | 30 | — | pF |

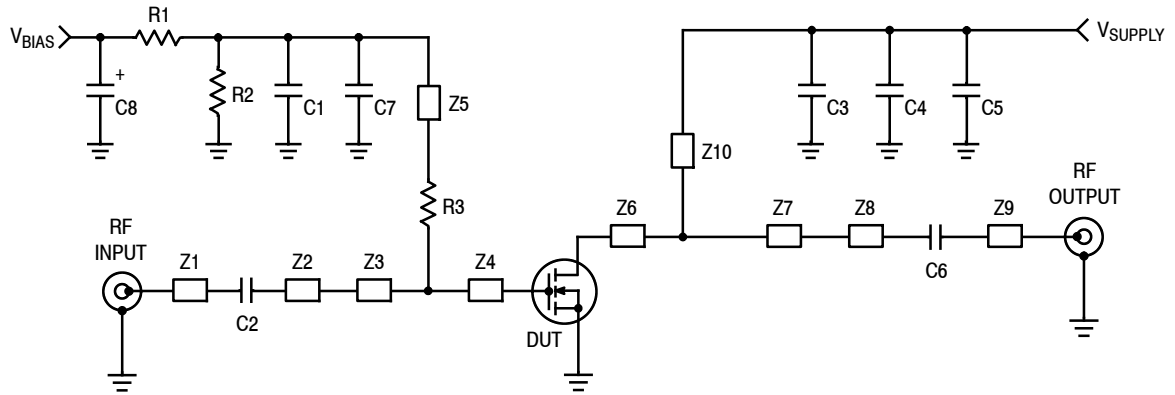
Functional Tests (In Freescale Test Fixture, 50 ohm system) $V_{DD} = 28\text{ Vdc}$, $I_{DQ} = 50\text{ mA}$, $P_{out} = 4\text{ W PEP}$, $f_1 = 1960\text{ MHz}$, $f_2 = 1960.1\text{ MHz}$, Two-Tone Test

| | | | | | |
|----------------------------|----------|------|-----|-----|-----|
| Power Gain | G_{ps} | 16.5 | 18 | 20 | dB |
| Drain Efficiency | η_D | 28 | 33 | — | % |
| Intermodulation Distortion | IMD | — | -34 | -28 | dBc |
| Input Return Loss | IRL | — | -12 | -10 | dB |

Typical Performance (In Freescale 900 MHz Demo Board, 50 ohm system) $V_{DD} = 28\text{ Vdc}$, $I_{DQ} = 50\text{ mA}$, $P_{out} = 4\text{ W PEP}$, $f = 900\text{ MHz}$, Two-Tone Test, 100 kHz Tone Spacing

| | | | | | |
|----------------------------|----------|---|-----|---|-----|
| Power Gain | G_{ps} | — | 19 | — | dB |
| Drain Efficiency | η_D | — | 33 | — | % |
| Intermodulation Distortion | IMD | — | -39 | — | dBc |
| Input Return Loss | IRL | — | -12 | — | dB |

1. $V_{GG} = \frac{11}{10} \times V_{GS(Q)}$. Parameter measured on Freescale Test Fixture, due to resistive divider network on the board. Refer to Test Circuit Schematic.



| | | | |
|----|----------------------------|-----|-----------------------------------------------------------|
| Z1 | 0.054" x 0.430" Microstrip | Z7 | 0.210" x 1.220" Microstrip |
| Z2 | 0.054" x 0.137" Microstrip | Z8 | 0.054" x 0.680" Microstrip |
| Z3 | 0.580" x 0.420" Microstrip | Z9 | 0.054" x 0.260" Microstrip |
| Z4 | 0.580" x 0.100" Microstrip | Z10 | 0.025" x 0.930" Microstrip |
| Z5 | 0.025" x 0.680" Microstrip | PCB | Arlon CuClad 250GX-0300-55-22, 0.020", $\epsilon_r = 2.5$ |
| Z6 | 0.210" x 0.100" Microstrip | | |

Figure 2. MMRF1014NT1 Test Circuit Schematic

Table 6. MMRF1014NT1 Test Circuit Component Designations and Values

| Part | Description | Part Number | Manufacturer |
|----------------|------------------------------------------|--------------------|--------------|
| C1 | 100 nF Chip Capacitor | CDR33BX104AKYS | Kemet |
| C2, C3, C6, C7 | 9.1 pF Chip Capacitors | ATC100B9R1CT500XT | ATC |
| C4, C5 | 10 μ F, 50 V Chip Capacitors | GRM55DR61H106KA88B | Murata |
| C8 | 10 μ F, 35 V Tantalum Chip Capacitor | T490D106K035AT | Kemet |
| R1 | 1 k Ω , 1/4 W Chip Resistor | CRCW12061001FKEA | Vishay |
| R2 | 10 k Ω , 1/4 W Chip Resistor | CRCW12061002FKEA | Vishay |
| R3 | 10 Ω , 1/4 W Chip Resistor | CRCW120610R0FKEA | Vishay |

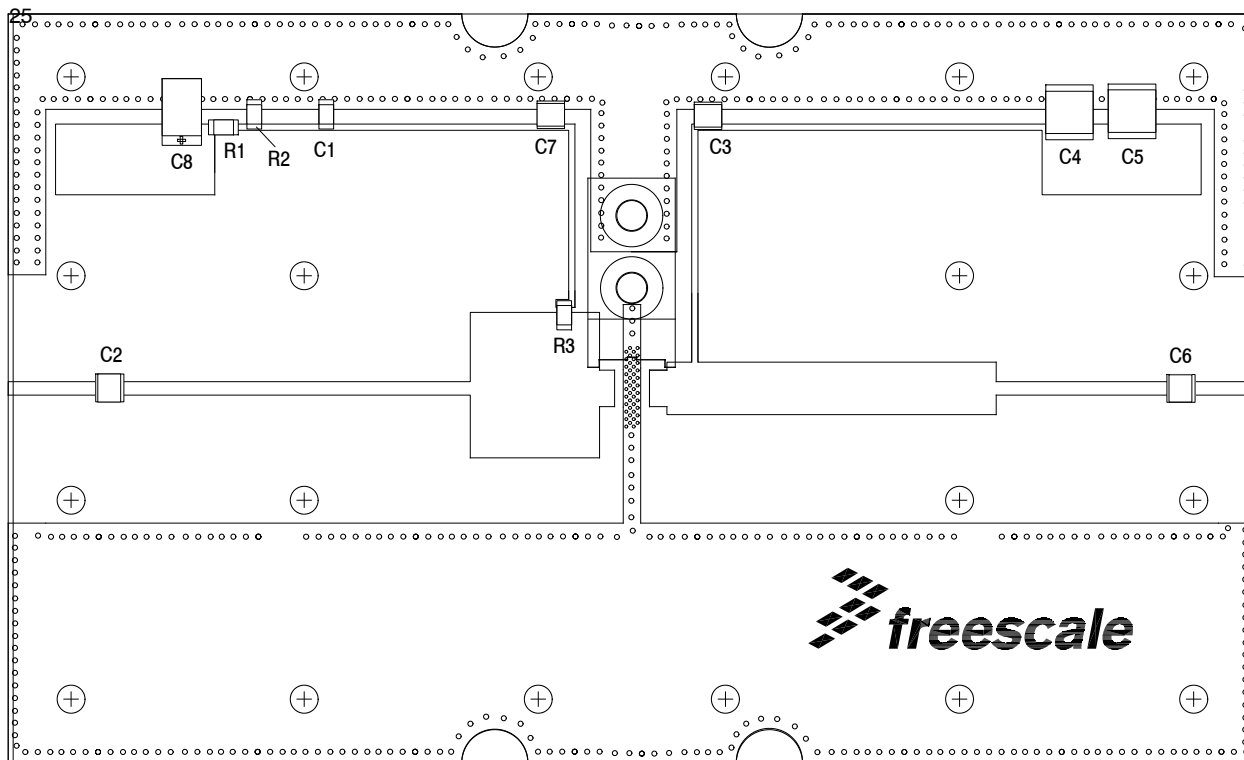


Figure 3. MMRF1014NT1 Test Circuit Component Layout

TYPICAL CHARACTERISTICS

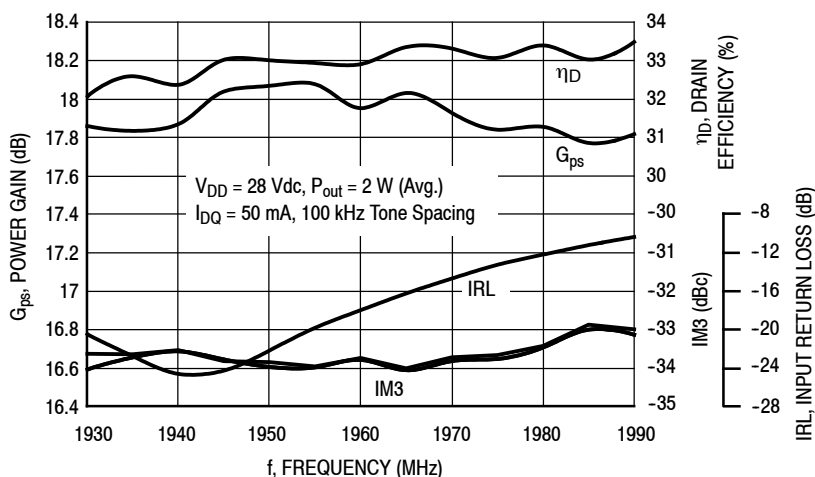


Figure 4. Two-Tone Wideband Performance @ $P_{out} = 2 \text{ Watts Avg.}$

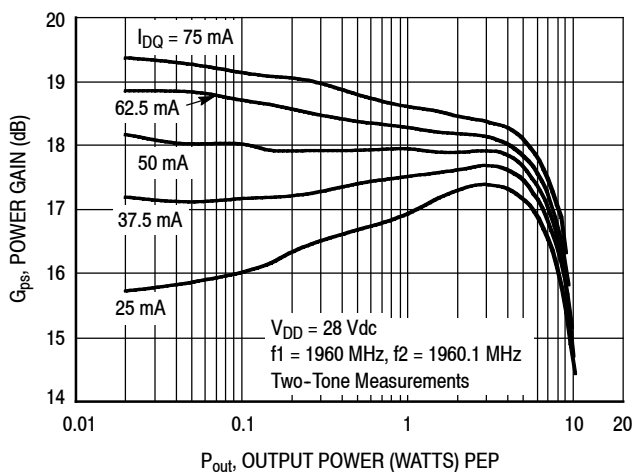


Figure 5. Two-Tone Power Gain versus Output Power

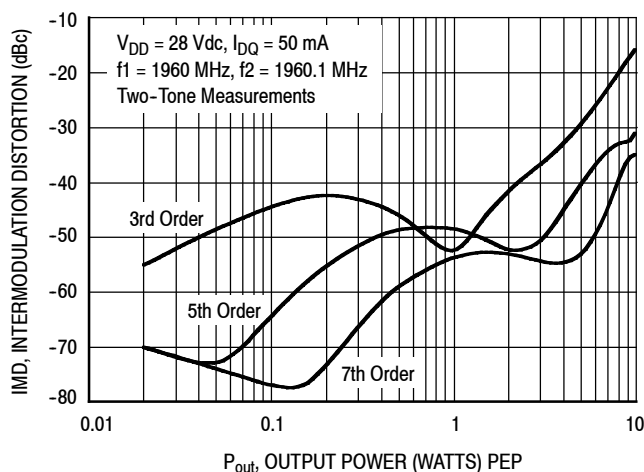


Figure 6. Intermodulation Distortion Products versus Output Power

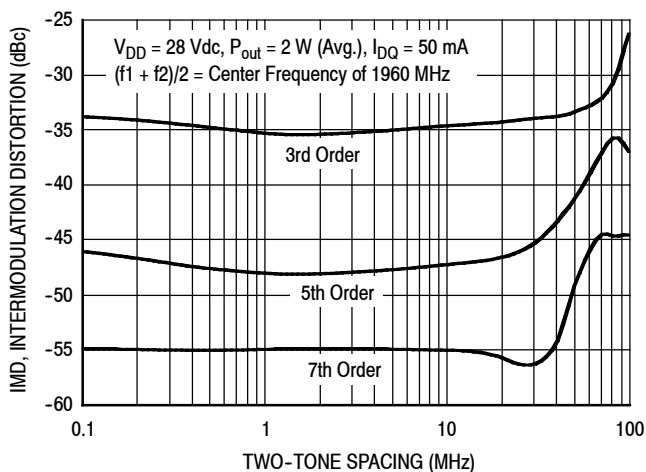


Figure 7. Intermodulation Distortion Products versus Tone Spacing

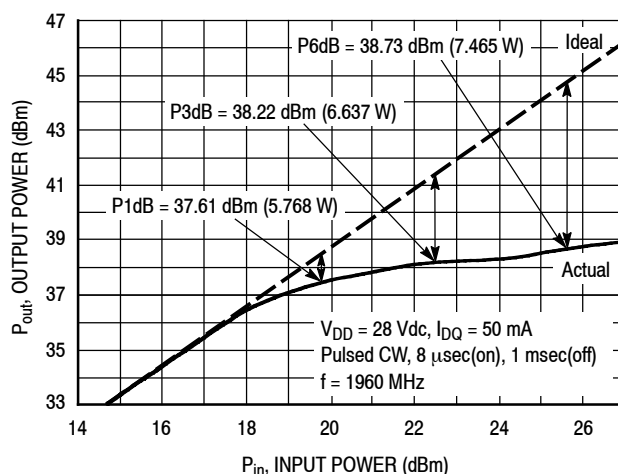


Figure 8. Pulsed CW Output Power versus Input Power

TYPICAL CHARACTERISTICS

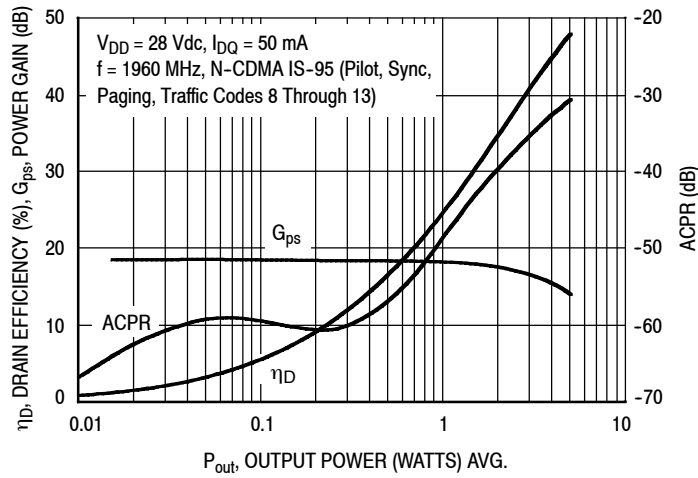


Figure 9. Single-Carrier CDMA ACPR, Power Gain and Drain Efficiency versus Output Power

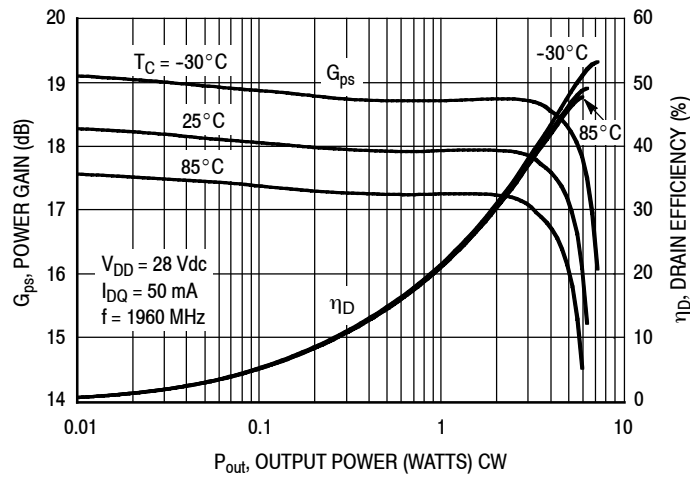


Figure 10. Power Gain and Drain Efficiency versus CW Output Power

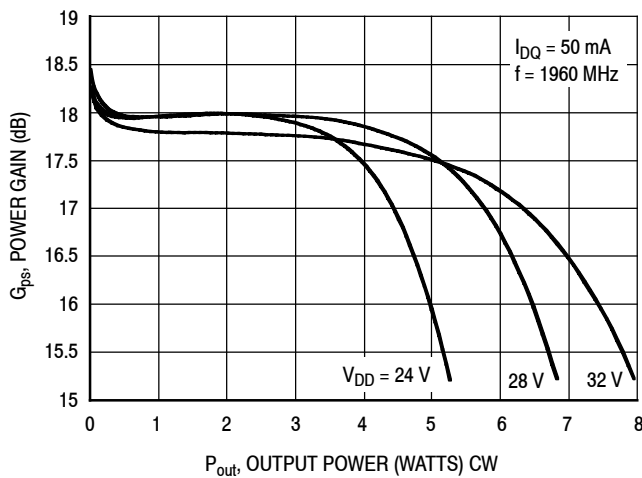


Figure 11. Power Gain versus Output Power

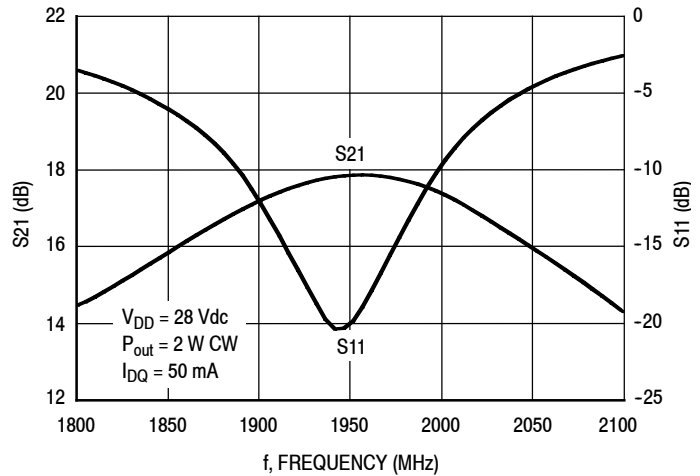
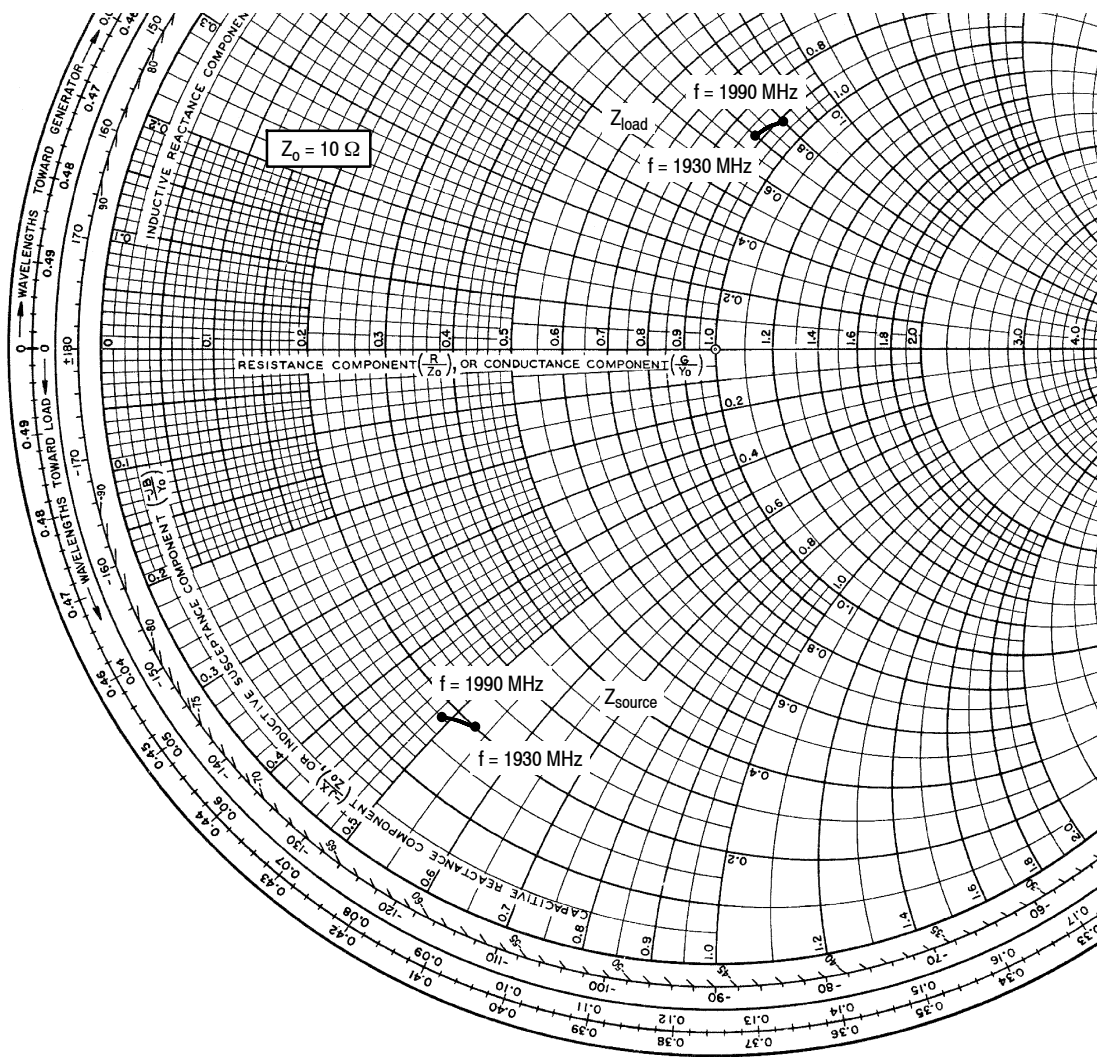


Figure 12. Broadband Frequency Response



$V_{DD} = 28 \text{ Vdc}$, $I_{DQ} = 50 \text{ mA}$, $P_{out} = 4 \text{ W PEP}$

| f MHz | Z_{source} Ω | Z_{load} Ω |
|----------|--------------------------|------------------------|
| 1930 | $1.96 - j5.34$ | $8.78 + j6.96$ |
| 1960 | $1.89 - j5.10$ | $8.93 + j7.46$ |
| 1990 | $1.82 - j4.85$ | $9.11 + j7.97$ |

Z_{source} = Test circuit impedance as measured from gate to ground.

Z_{load} = Test circuit impedance as measured from drain to ground.

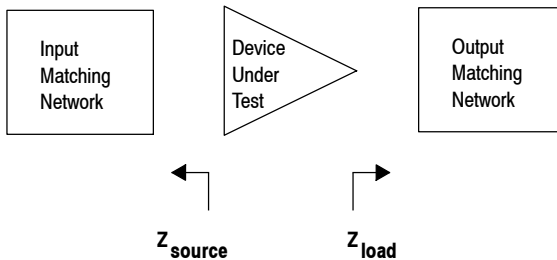


Figure 13. Series Equivalent Source and Load Impedance

Table 7. Common Source S-Parameters ($V_{DD} = 28 \text{ Vdc}$, $I_{DQ} = 50 \text{ mA}$, $T_A = 25^\circ\text{C}$, 50 Ohm System)

| f MHz | S ₁₁ | | S ₂₁ | | S ₁₂ | | S ₂₂ | |
|----------|-----------------|----------|-----------------|---------|-----------------|----------|-----------------|----------|
| | S ₁₁ | ∠ φ | S ₂₁ | ∠ φ | S ₁₂ | ∠ φ | S ₂₂ | ∠ φ |
| 500 | 0.649 | -116.340 | 7.902 | 105.420 | 0.056 | -73.750 | 0.548 | -33.570 |
| 550 | 0.695 | -121.680 | 7.502 | 98.790 | 0.053 | -80.570 | 0.593 | -41.480 |
| 600 | 0.733 | -126.560 | 7.111 | 92.380 | 0.049 | -87.010 | 0.632 | -48.890 |
| 650 | 0.770 | -131.340 | 6.699 | 86.290 | 0.045 | -93.280 | 0.669 | -56.000 |
| 700 | 0.800 | -135.740 | 6.302 | 80.450 | 0.041 | -99.120 | 0.701 | -62.810 |
| 750 | 0.827 | -140.030 | 5.922 | 74.850 | 0.038 | -104.850 | 0.727 | -69.290 |
| 800 | 0.848 | -143.950 | 5.552 | 69.630 | 0.035 | -110.110 | 0.750 | -75.350 |
| 850 | 0.866 | -147.690 | 5.220 | 64.580 | 0.032 | -115.220 | 0.770 | -81.130 |
| 900 | 0.882 | -151.140 | 4.891 | 59.970 | 0.029 | -119.960 | 0.786 | -86.570 |
| 950 | 0.895 | -154.560 | 4.597 | 55.490 | 0.026 | -124.790 | 0.800 | -91.730 |
| 1000 | 0.907 | -157.590 | 4.315 | 51.240 | 0.024 | -129.090 | 0.813 | -96.660 |
| 1050 | 0.916 | -160.540 | 4.060 | 47.170 | 0.022 | -133.370 | 0.824 | -101.340 |
| 1100 | 0.923 | -163.310 | 3.819 | 43.340 | 0.020 | -137.460 | 0.833 | -105.790 |
| 1150 | 0.929 | -165.930 | 3.601 | 39.650 | 0.018 | -141.440 | 0.840 | -110.050 |
| 1200 | 0.935 | -168.430 | 3.398 | 36.110 | 0.017 | -145.330 | 0.847 | -114.170 |
| 1250 | 0.938 | -170.770 | 3.210 | 32.740 | 0.015 | -149.540 | 0.851 | -118.060 |
| 1300 | 0.942 | -173.030 | 3.036 | 29.490 | 0.014 | -153.430 | 0.856 | -121.880 |
| 1350 | 0.945 | -175.140 | 2.875 | 26.360 | 0.013 | -157.460 | 0.859 | -125.520 |
| 1400 | 0.948 | -177.170 | 2.728 | 23.330 | 0.012 | -161.910 | 0.863 | -129.020 |
| 1450 | 0.951 | -179.090 | 2.590 | 20.440 | 0.011 | -166.180 | 0.866 | -132.390 |
| 1500 | 0.953 | 179.030 | 2.464 | 17.640 | 0.010 | -170.630 | 0.869 | -135.650 |
| 1550 | 0.954 | 177.270 | 2.347 | 14.920 | 0.009 | -174.890 | 0.872 | -138.760 |
| 1600 | 0.955 | 175.570 | 2.240 | 12.320 | 0.008 | 179.950 | 0.875 | -141.750 |
| 1650 | 0.956 | 173.980 | 2.139 | 9.740 | 0.008 | 173.920 | 0.877 | -144.650 |
| 1700 | 0.957 | 172.350 | 2.047 | 7.250 | 0.007 | 167.710 | 0.880 | -147.480 |
| 1750 | 0.957 | 170.800 | 1.958 | 4.810 | 0.007 | 161.810 | 0.882 | -150.180 |
| 1800 | 0.958 | 169.340 | 1.879 | 2.440 | 0.006 | 155.370 | 0.884 | -152.760 |
| 1850 | 0.959 | 167.920 | 1.806 | 0.260 | 0.006 | 148.940 | 0.886 | -155.230 |
| 1900 | 0.959 | 166.510 | 1.736 | -1.980 | 0.005 | 142.630 | 0.887 | -157.580 |
| 1950 | 0.960 | 165.200 | 1.668 | -4.310 | 0.005 | 136.740 | 0.888 | -160.050 |
| 2000 | 0.959 | 163.800 | 1.611 | -6.240 | 0.005 | 129.910 | 0.890 | -162.070 |
| 2050 | 0.959 | 162.420 | 1.555 | -8.290 | 0.005 | 123.810 | 0.891 | -164.190 |
| 2100 | 0.958 | 161.170 | 1.504 | -10.270 | 0.005 | 118.200 | 0.892 | -166.140 |
| 2150 | 0.958 | 159.840 | 1.456 | -12.210 | 0.005 | 112.740 | 0.893 | -168.060 |
| 2200 | 0.957 | 158.560 | 1.412 | -14.130 | 0.005 | 108.460 | 0.894 | -169.840 |
| 2250 | 0.957 | 157.160 | 1.372 | -16.010 | 0.005 | 103.840 | 0.896 | -171.610 |
| 2300 | 0.955 | 155.870 | 1.334 | -17.870 | 0.005 | 99.310 | 0.896 | -173.260 |
| 2350 | 0.954 | 154.510 | 1.300 | -19.700 | 0.005 | 95.360 | 0.897 | -174.830 |
| 2400 | 0.953 | 153.120 | 1.268 | -21.510 | 0.005 | 91.030 | 0.898 | -176.390 |
| 2450 | 0.953 | 151.730 | 1.238 | -23.250 | 0.005 | 87.460 | 0.899 | -177.840 |

(continued)

Table 7. Common Source S-Parameters ($V_{DD} = 28$ Vdc, $I_{DQ} = 50$ mA, $T_A = 25^\circ\text{C}$, 50 Ohm System) (continued)

| f MHz | S ₁₁ | | S ₂₁ | | S ₁₂ | | S ₂₂ | |
|----------|-----------------|---------|-----------------|---------|-----------------|--------|-----------------|----------|
| | S ₁₁ | ∠ φ | S ₂₁ | ∠ φ | S ₁₂ | ∠ φ | S ₂₂ | ∠ φ |
| 2500 | 0.952 | 150.340 | 1.211 | -25.120 | 0.006 | 84.160 | 0.899 | -179.270 |
| 2550 | 0.950 | 149.010 | 1.187 | -26.920 | 0.006 | 80.780 | 0.897 | 179.420 |
| 2600 | 0.949 | 147.380 | 1.166 | -28.650 | 0.006 | 77.880 | 0.897 | 178.120 |
| 2650 | 0.948 | 145.920 | 1.144 | -30.420 | 0.007 | 74.670 | 0.898 | 176.840 |
| 2700 | 0.944 | 144.200 | 1.121 | -32.310 | 0.007 | 71.360 | 0.896 | 175.480 |
| 2750 | 0.944 | 142.790 | 1.105 | -34.230 | 0.007 | 67.980 | 0.897 | 174.060 |
| 2800 | 0.943 | 141.020 | 1.088 | -36.000 | 0.007 | 63.950 | 0.897 | 172.930 |
| 2850 | 0.941 | 139.410 | 1.073 | -37.870 | 0.007 | 61.230 | 0.896 | 171.630 |
| 2900 | 0.940 | 137.640 | 1.058 | -39.760 | 0.008 | 59.810 | 0.896 | 170.330 |
| 2950 | 0.938 | 135.900 | 1.045 | -41.680 | 0.008 | 58.280 | 0.896 | 169.040 |
| 3000 | 0.937 | 133.860 | 1.032 | -43.610 | 0.008 | 56.740 | 0.895 | 167.510 |

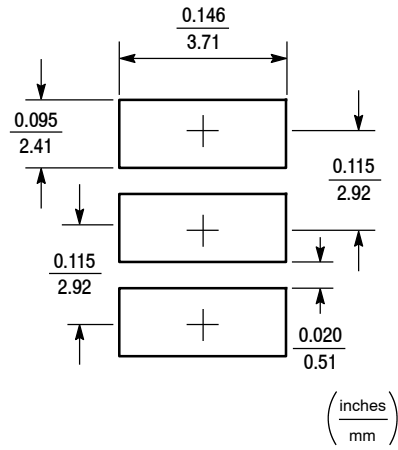


Figure 14. Solder Footprint for PLD-1.5

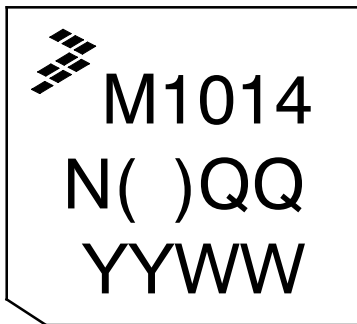
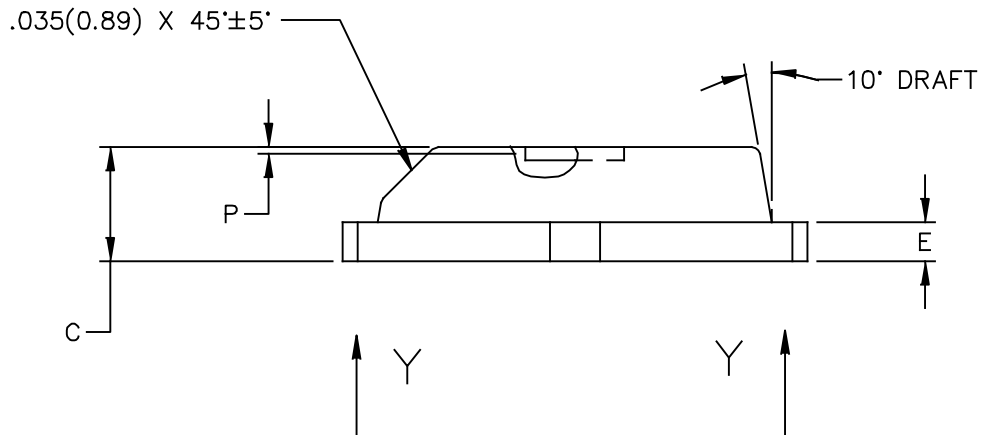
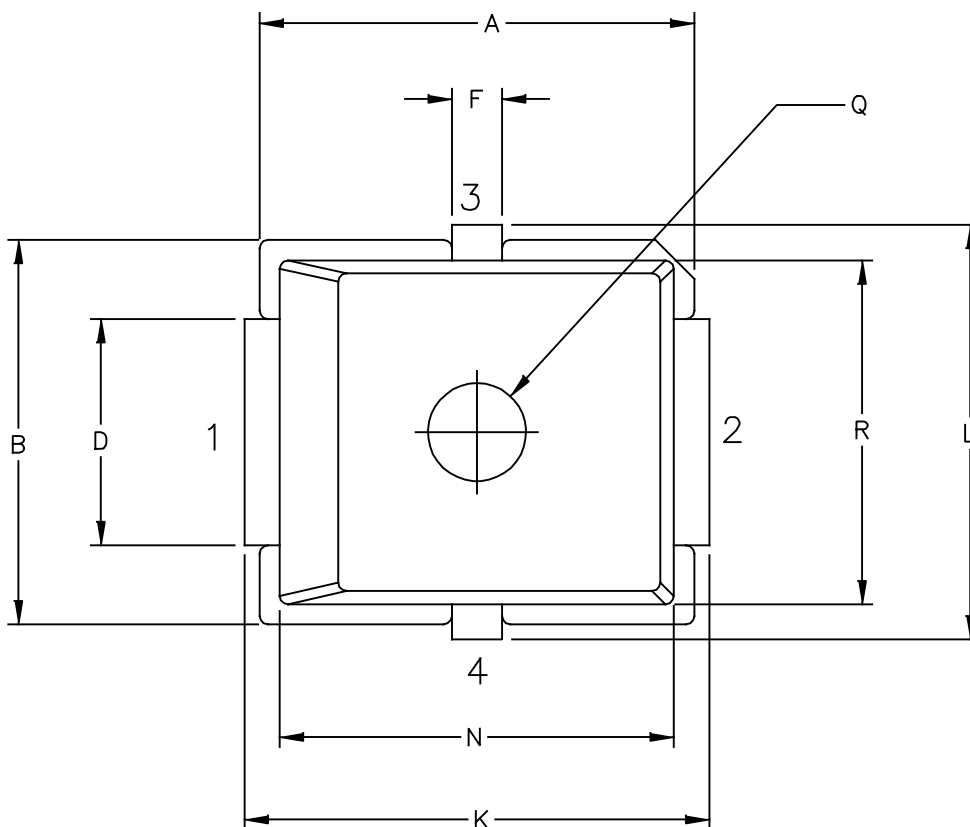
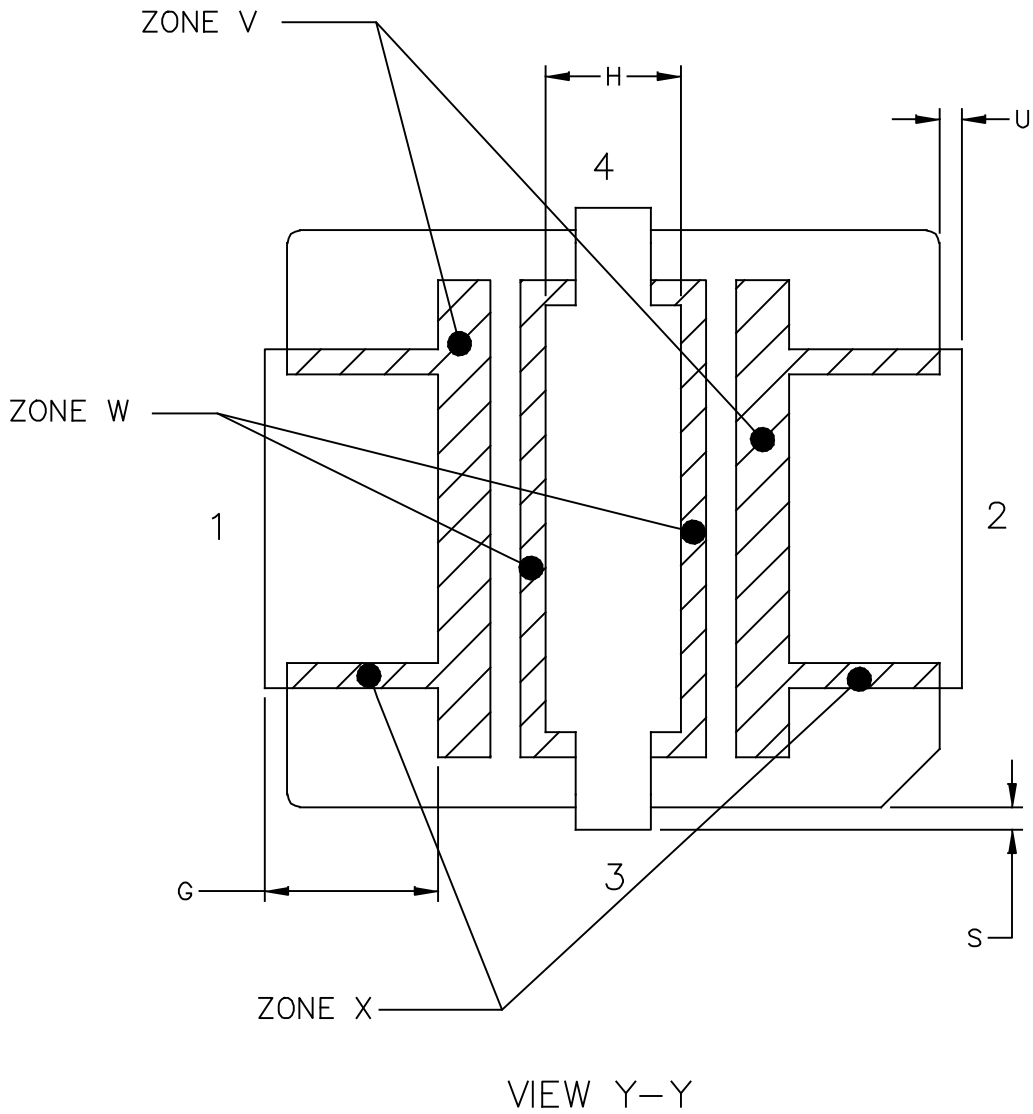


Figure 15. Product Marking

PACKAGE DIMENSIONS



| | | | |
|---------------------------------------------------------|--------------------------|----------------------------|--|
| © FREESCALE SEMICONDUCTOR, INC. ALL RIGHTS RESERVED. | MECHANICAL OUTLINE | PRINT VERSION NOT TO SCALE | |
| TITLE: PLD-1.5 | DOCUMENT NO: 98ASB15740C | REV: D | |
| | CASE NUMBER: 466-03 | 31 MAR 2005 | |
| | STANDARD: NON-JEDEC | | |



| | | | |
|---------------------------------------------------------|--|--------------------------|----------------------------|
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| TITLE: PLD-1.5 | | DOCUMENT NO: 98ASB15740C | REV: D |
| | | CASE NUMBER: 466-03 | 31 MAR 2005 |
| | | STANDARD: NON-JEDEC | |

NOTES:

1. CONTROLLING DIMENSION: INCH
2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M-1994.
3. RESIN BLEED/FLASH ALLOWABLE IN ZONES V, W AND X.

STYLE 1:

- PIN 1 - DRAIN
- PIN 2 - GATE
- PIN 3 - SOURCE
- PIN 4 - SOURCE

| DIM | INCH | | MILLIMETER | | DIM | INCH | | MILLIMETER | |
|---------------------------------------------------------|------|------|--------------------|------|--------------------------|----------------------------|------|-------------|------|
| | MIN | MAX | MIN | MAX | | MIN | MAX | MIN | MAX |
| A | .255 | .265 | 6.48 | 6.73 | Q | .055 | .063 | 1.40 | 1.60 |
| B | .225 | .235 | 5.72 | 5.97 | R | .200 | .210 | 5.08 | 5.33 |
| C | .065 | .072 | 1.65 | 1.83 | S | .006 | .012 | 0.15 | 0.31 |
| D | .130 | .150 | 3.30 | 3.81 | U | .006 | .012 | 0.15 | 0.31 |
| E | .021 | .026 | 0.53 | 0.66 | ZONE V | .000 | .021 | 0.00 | 0.53 |
| F | .026 | .044 | 0.66 | 1.12 | ZONE W | .000 | .010 | 0.00 | 0.25 |
| G | .050 | .070 | 1.27 | 1.78 | ZONE X | .000 | .010 | 0.00 | 0.25 |
| H | .045 | .063 | 1.14 | 1.60 | | | | | |
| J | .160 | .180 | 4.06 | 4.57 | | | | | |
| K | .273 | .285 | 6.93 | 7.24 | | | | | |
| L | .245 | .255 | 6.22 | 6.48 | | | | | |
| N | .230 | .240 | 5.84 | 6.10 | | | | | |
| P | .000 | .008 | 0.00 | 0.20 | | | | | |
| © FREESCALE SEMICONDUCTOR, INC. ALL RIGHTS RESERVED. | | | MECHANICAL OUTLINE | | | PRINT VERSION NOT TO SCALE | | | |
| TITLE: PLD-1.5 | | | | | DOCUMENT NO: 98ASB15740C | | | REV: D | |
| | | | | | CASE NUMBER: 466-03 | | | 31 MAR 2005 | |
| | | | | | STANDARD: NON-JEDEC | | | | |

PRODUCT DOCUMENTATION AND SOFTWARE

Refer to the following resources to aid your design process.

Application Notes

- AN1955: Thermal Measurement Methodology of RF Power Amplifiers

Engineering Bulletins

- EB212: Using Data Sheet Impedances for RF LDMOS Devices

Software

- Electromigration MTTF Calculator

For Software, do a Part Number search at <http://www.freescale.com>, and select the “Part Number” link. Go to the Software & Tools tab on the part’s Product Summary page to download the respective tool.

REVISION HISTORY

The following table summarizes revisions to this document.

| Revision | Date | Description |
|----------|-----------|-----------------------------------------------------------------------------------|
| 0 | July 2014 | <ul style="list-style-type: none"> • Initial Release of Data Sheet |

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Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



Телефон: 8 (812) 309-75-97 (многоканальный)

Факс: 8 (812) 320-03-32

Электронная почта: ocean@oceanchips.ru

Web: <http://oceanchips.ru/>

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, д. 2, корп. 4, лит. А